

V_{DSS}	650V
$R_{DS(on)}$ (Typ.)	30mΩ
I_D^{*1}	70A
P_D	262W

●Features

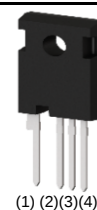
- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

●Application

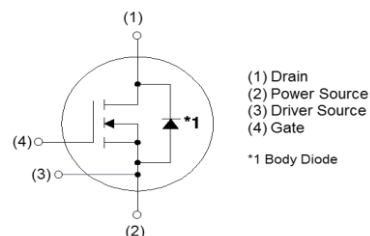
- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating
- Motor drives

●Outline

TO-247-4L



●Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

●Packaging specifications

Type	Packing	Tube
	Reel size (mm)	-
	Tape width (mm)	-
	Basic ordering unit (pcs)	30
	Taping code	C14
	Marking	SCT3030AR

●Absolute maximum ratings ($T_a = 25^\circ\text{C}$)

Parameter		Symbol	Value	Unit
Drain - Source Voltage		V_{DSS}	650	V
Continuous Drain current	$T_c = 25^\circ\text{C}$	I_D^{*1}	70	A
	$T_c = 100^\circ\text{C}$	I_D^{*1}	49	A
Pulsed Drain current		$I_{D,pulse}^{*2}$	175	A
Gate - Source voltage (DC)		V_{GSS}	-4 to +22	V
Gate - Source surge voltage ($t_{surge} < 300\text{ns}$)		$V_{GSS,surge}^{*3}$	-4 to +26	V
Recommended drive voltage		$V_{GS,op}^{*4}$	0 / +18	V
Junction temperature		T_j	175	$^\circ\text{C}$
Range of storage temperature		T_{stg}	-55 to +175	$^\circ\text{C}$

●Electrical characteristics ($T_a = 25^\circ\text{C}$)

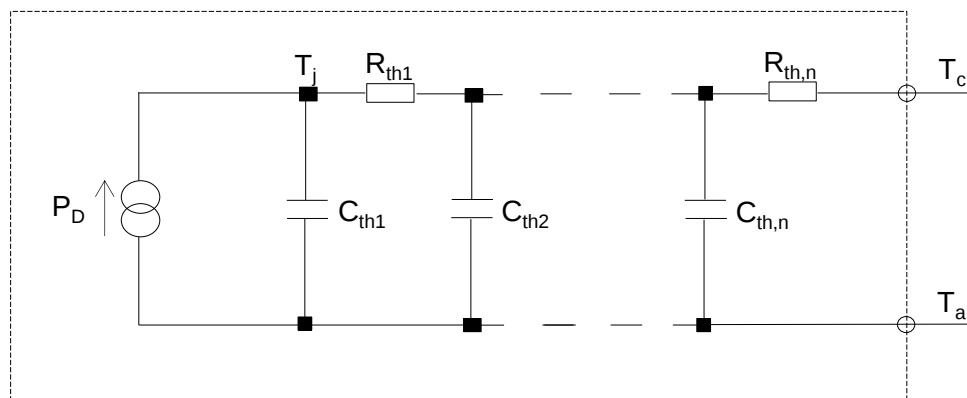
Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$ $T_j = 25^\circ\text{C}$ $T_j = -55^\circ\text{C}$	650 650	- -	- -	V
Zero Gate voltage Drain current	I_{DSS}	$V_{GS} = 0V, V_{DS} = 650V$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	1 2	10 -	μA
Gate - Source leakage current	I_{GSS+}	$V_{GS} = +22V, V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current	I_{GSS-}	$V_{GS} = -4V, V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = 10V, I_D = 13.3mA$	2.7	-	5.6	V
Static Drain - Source on - state resistance	$R_{DS(on)}^{*5}$	$V_{GS} = 18V, I_D = 27A$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	30 43	39 -	m Ω
Gate input resistance	R_G	$f = 1\text{MHz}, \text{open drain}$	-	7	-	Ω

●Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - case	R_{thJC}	-	0.44	0.57	$^\circ\text{C/W}$

●Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R_{th1}	2.56×10^{-2}	K/W	C_{th1}	1.39×10^{-3}	Ws/K
R_{th2}	1.95×10^{-1}		C_{th2}	1.00×10^{-2}	
R_{th3}	2.20×10^{-1}		C_{th3}	3.57×10^{-2}	



●Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Transconductance	g_{fs}^{*5}	$V_{DS} = 10\text{V}, I_D = 27\text{A}$	-	9.4	-	S
Input capacitance	C_{iss}	$V_{GS} = 0\text{V}$	-	1526	-	pF
Output capacitance	C_{oss}	$V_{DS} = 500\text{V}$	-	89	-	
Reverse transfer capacitance	C_{rss}	$f = 1\text{MHz}$	-	42	-	
Effective output capacitance, energy related	$C_{o(er)}$	$V_{GS} = 0\text{V}$ $V_{DS} = 0\text{V to } 300\text{V}$	-	230	-	pF
Total Gate charge	Q_g^{*5}	$V_{DS} = 300\text{V}$ $I_D = 27\text{A}$	-	104	-	nC
Gate - Source charge	Q_{gs}^{*5}	$V_{GS} = 18\text{V}$	-	19	-	
Gate - Drain charge	Q_{gd}^{*5}	See Fig. 1-1.	-	55	-	
Turn - on delay time	$t_{d(on)}^{*5}$	$V_{DS} = 400\text{V}$ $I_D = 27\text{A}$	-	7	-	ns
Rise time	t_r^{*5}	$V_{GS} = 0\text{V}/+18\text{V}$	-	22	-	
Turn - off delay time	$t_{d(off)}^{*5}$	$R_G = 0\Omega, L = 750\mu\text{H}$ $L_\sigma = 50\text{nH}, C_\sigma = 10\text{pF}$	-	27	-	
Fall time	t_f^{*5}	See Fig. 2-1, 2-2, 2-3.	-	21	-	
Turn - on switching loss	E_{on}^{*5}	E_{on} includes diode reverse recovery.	-	159	-	μJ
Turn - off switching loss	E_{off}^{*5}		-	87	-	

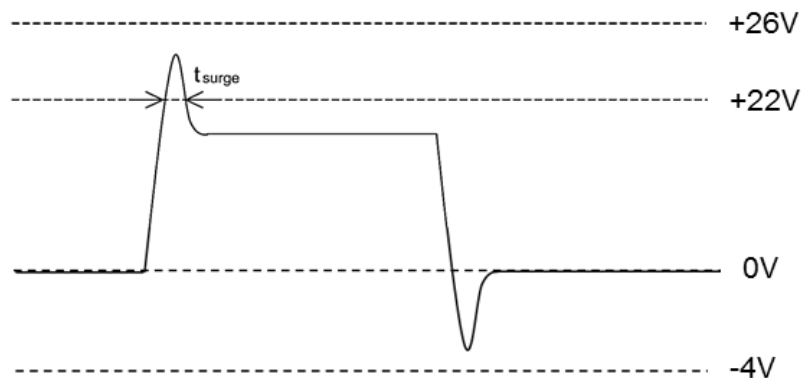
●Body diode electrical characteristics (Source-Drain) ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Body diode continuous, forward current	I_S^{*1}	$T_c = 25^\circ\text{C}$	-	-	70	A
Body diode direct current, pulsed	I_{SM}^{*2}		-	-	175	A
Forward voltage	V_{SD}^{*5}	$V_{GS} = 0\text{V}, I_D = 27\text{A}$	-	3.2	-	V
Reverse recovery time	t_{rr}^{*5}	$I_F = 27\text{A}$ $V_R = 400\text{V}$ $di/dt = 2500\text{A}/\mu\text{s}$ $L_\sigma = 50\text{nH}, C_\sigma = 10\text{pF}$ See Fig. 3-1, 3-2.	-	28	-	ns
Reverse recovery charge	Q_{rr}^{*5}		-	702	-	nC
Peak reverse recovery current	I_{rrm}^{*5}		-	40	-	A

*1 Limited by maximum temperature allowed.

*2 $P_W \leq 10\mu\text{s}$, Duty cycle $\leq 1\%$

*3 Example of acceptable V_{GS} waveform



Please note especially when using driver source that V_{GSS_surge} must be in the range of absolute maximum rating.

*4 Please be advised not to use SiC-MOSFETs with V_{GS} below 13V as doing so may cause thermal runaway.

*5 Pulsed

●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

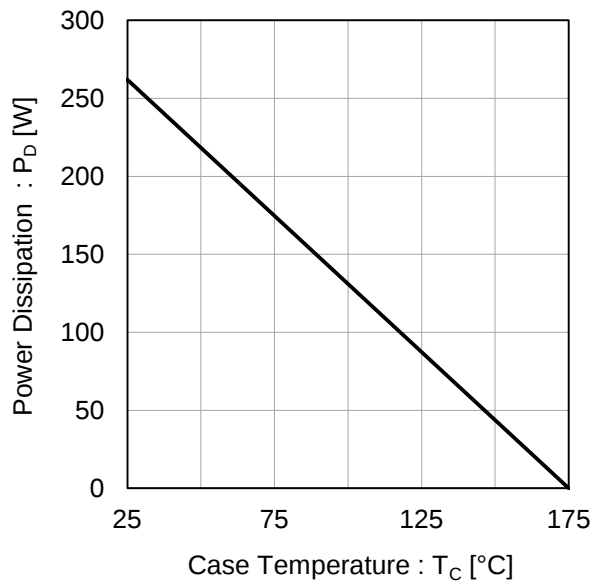


Fig.2 Maximum Safe Operating Area

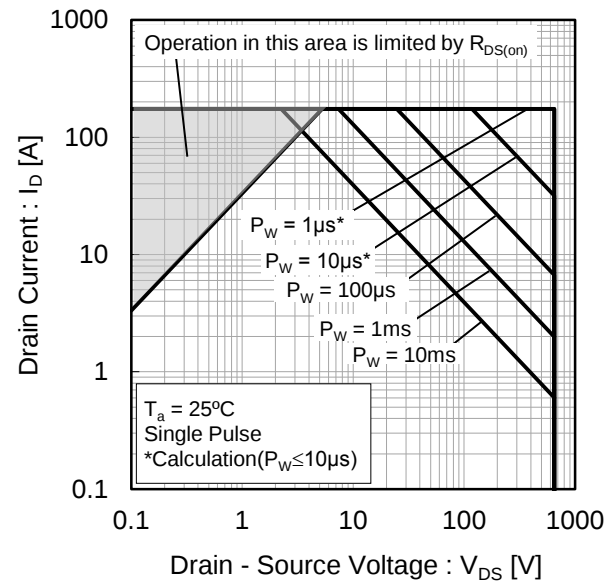
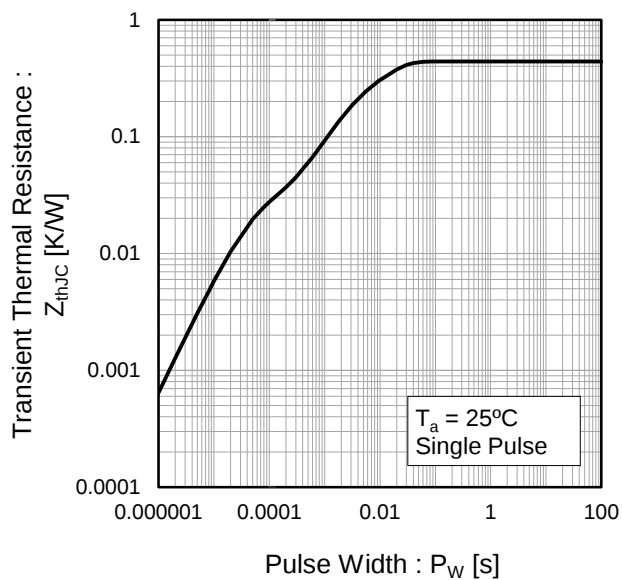


Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



●Electrical characteristic curves

Fig.4 Typical Output Characteristics(I)

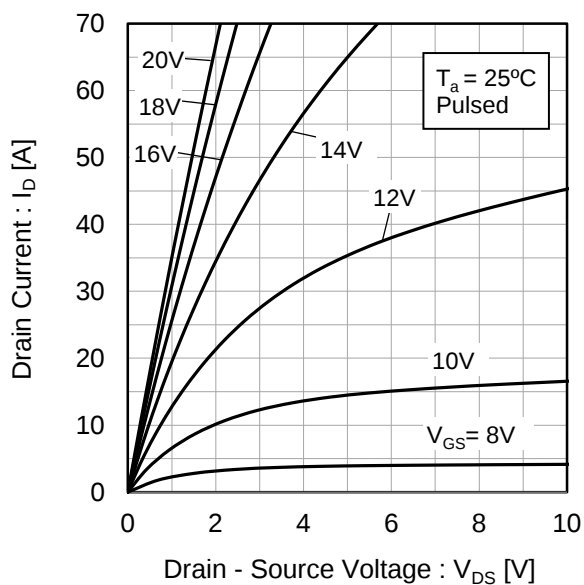
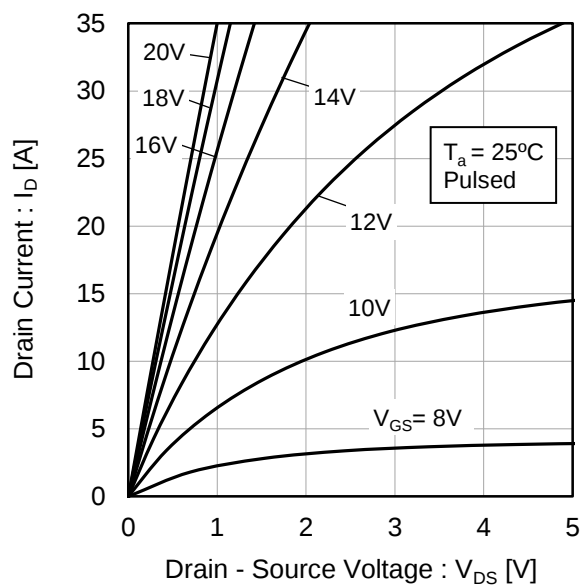
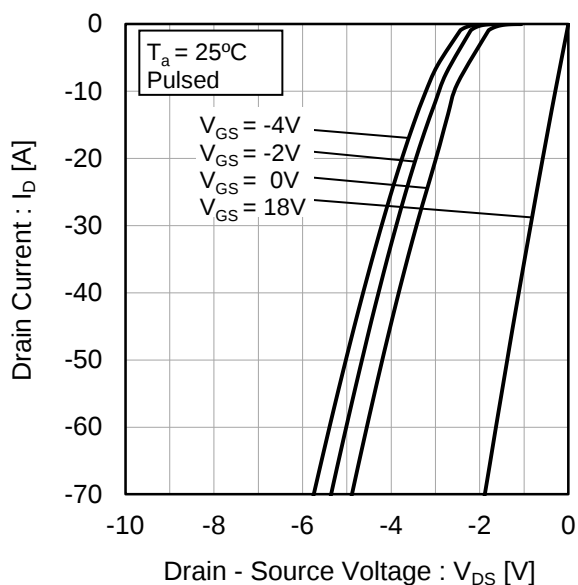


Fig.5 Typical Output Characteristics(II)

Fig.6 $T_j = 25^\circ\text{C}$ 3rd Quadrant Characteristics

●Electrical characteristic curves

Fig.7 $T_j = 150^\circ\text{C}$ Typical Output Characteristics(I)

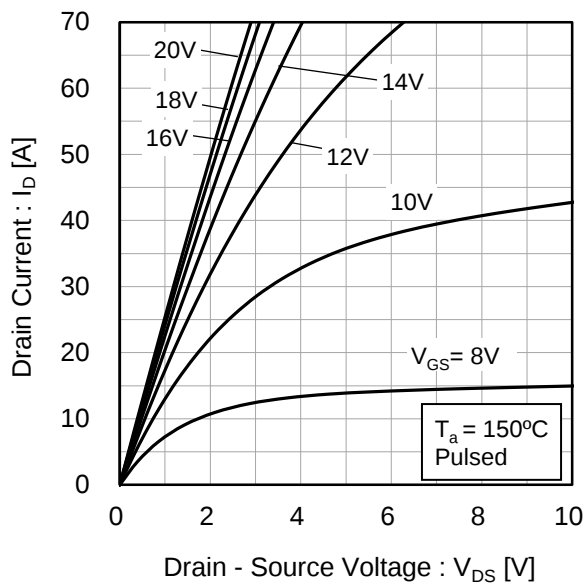


Fig.8 $T_j = 150^\circ\text{C}$ Typical Output Characteristics(II)

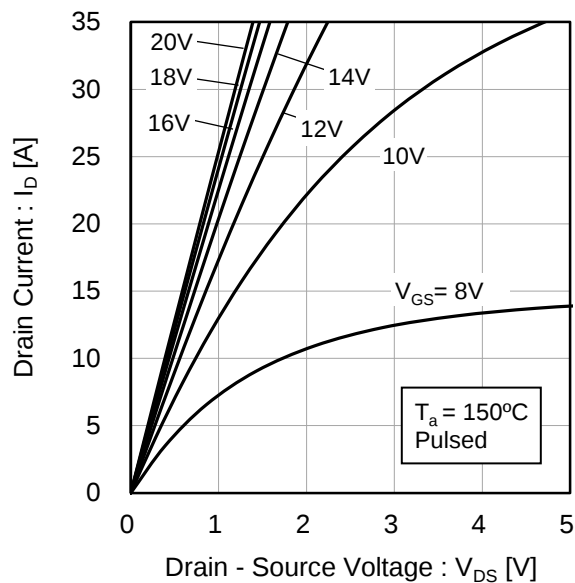


Fig.9 $T_j = 150^\circ\text{C}$ 3rd Quadrant Characteristics

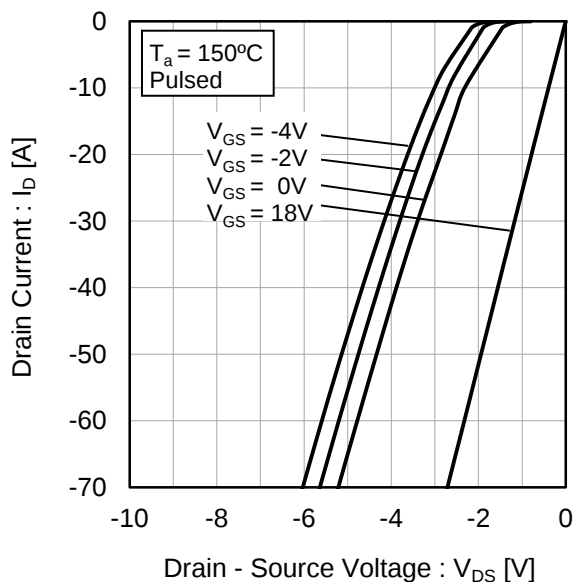
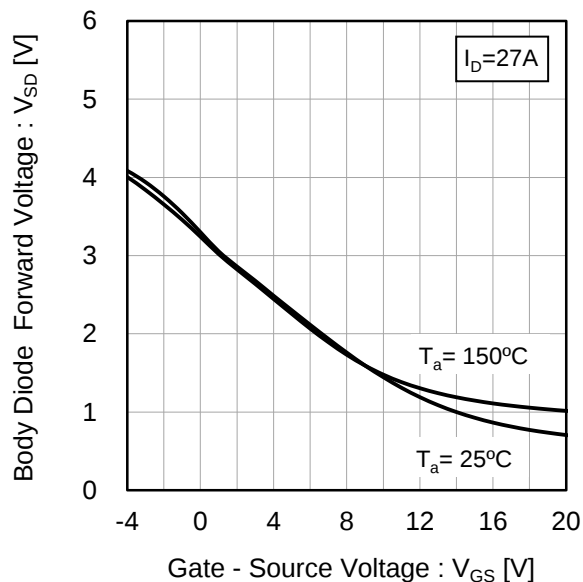


Fig.10 Body Diode Forward Voltage vs. Gate - Source Voltage



●Electrical characteristic curves

Fig.11 Typical Transfer Characteristics (I)

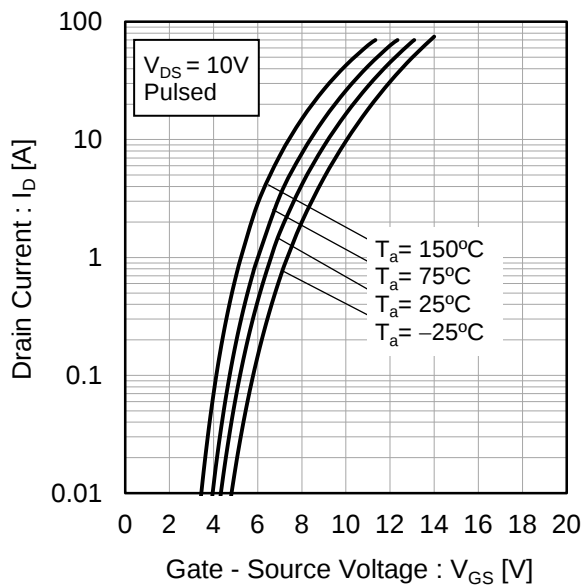


Fig.12 Typical Transfer Characteristics (II)

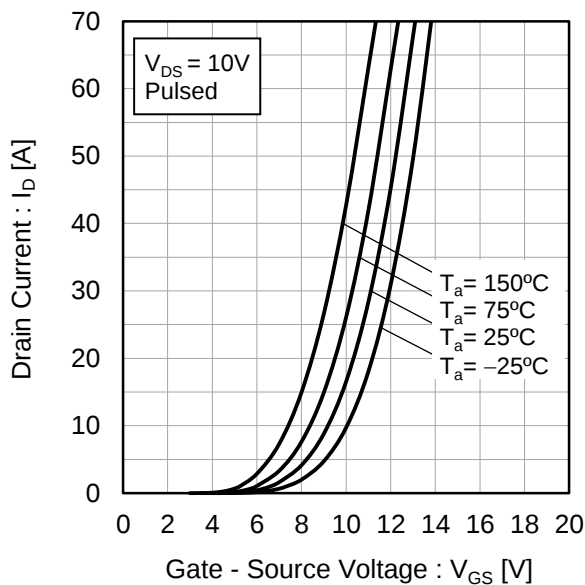


Fig.13 Gate Threshold Voltage vs. Junction Temperature

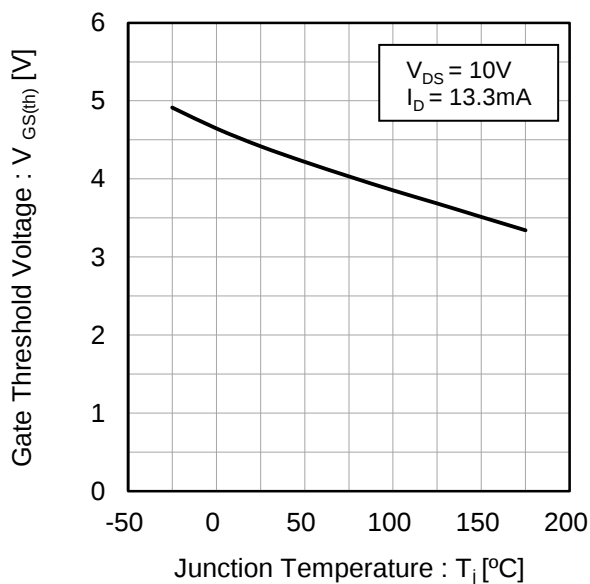
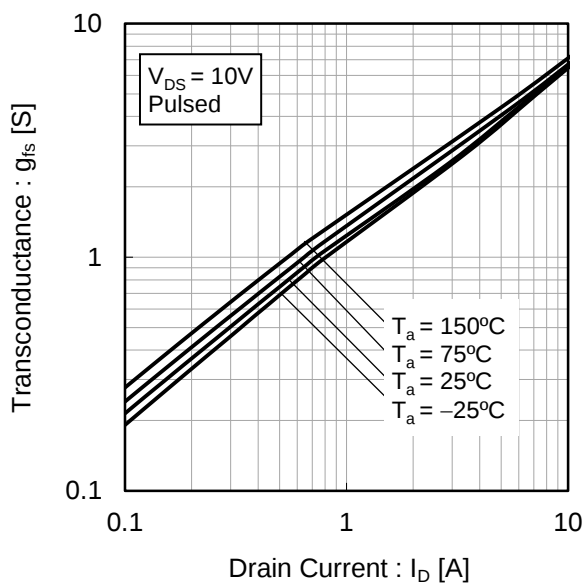


Fig.14 Transconductance vs. Drain Current



●Electrical characteristic curves

Fig.15 Static Drain - Source On - State Resistance vs. Gate - Source Voltage

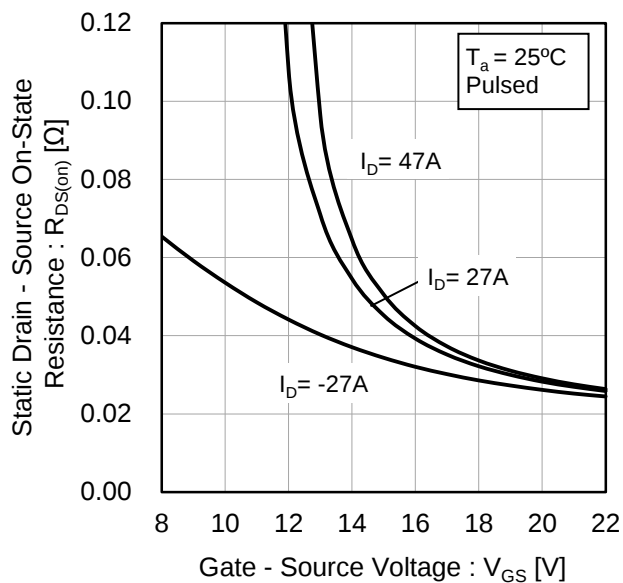


Fig.16 Static Drain - Source On - State Resistance vs. Junction Temperature

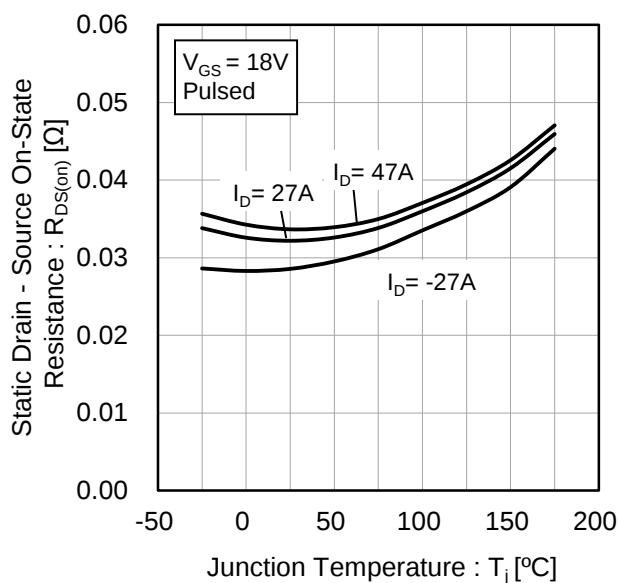


Fig.17 Static Drain - Source On - State Resistance vs. Drain Current

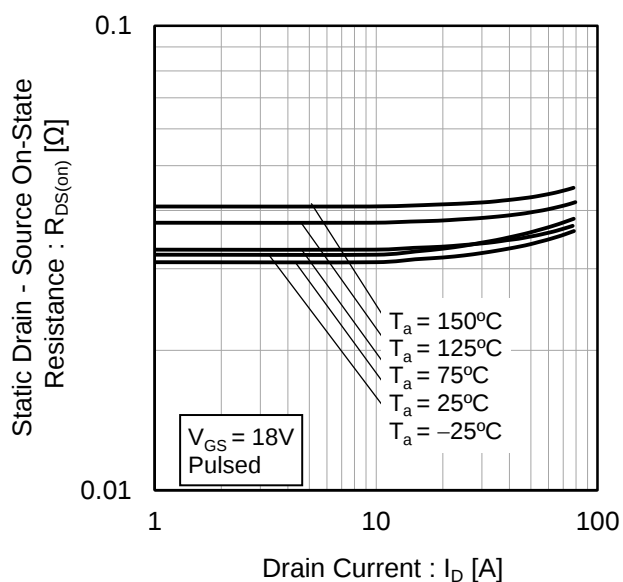
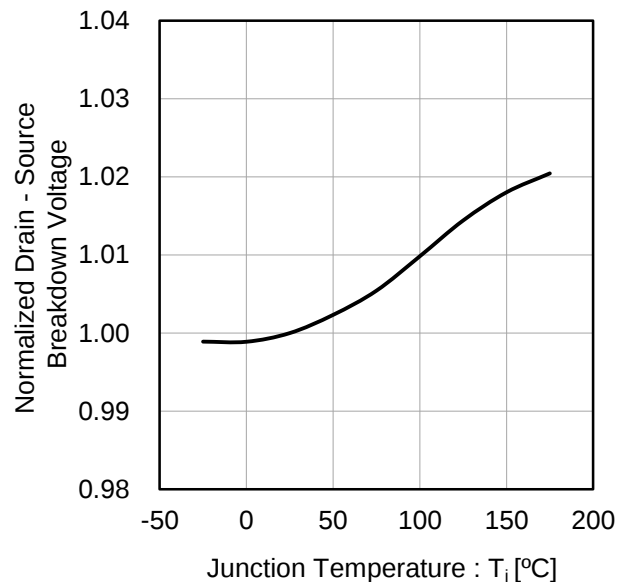


Fig.18 Normalized Drain - Source Breakdown Voltage vs. Junction Temperature



●Electrical characteristic curves

Fig.19 Typical Capacitance
vs. Drain - Source Voltage

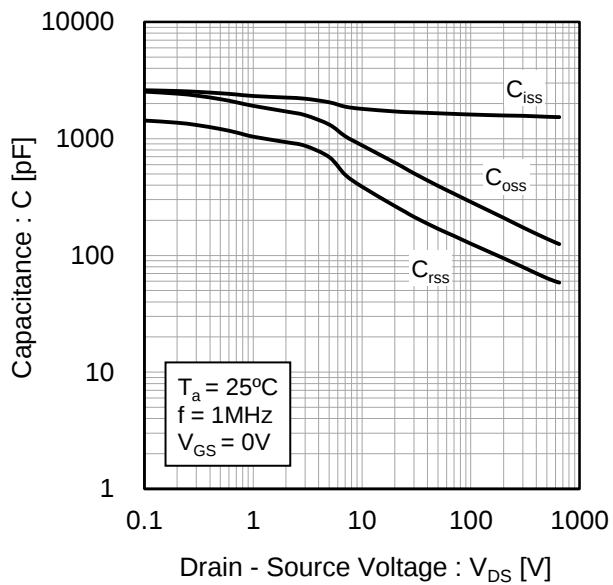


Fig.20 C_{oss} Stored Energy

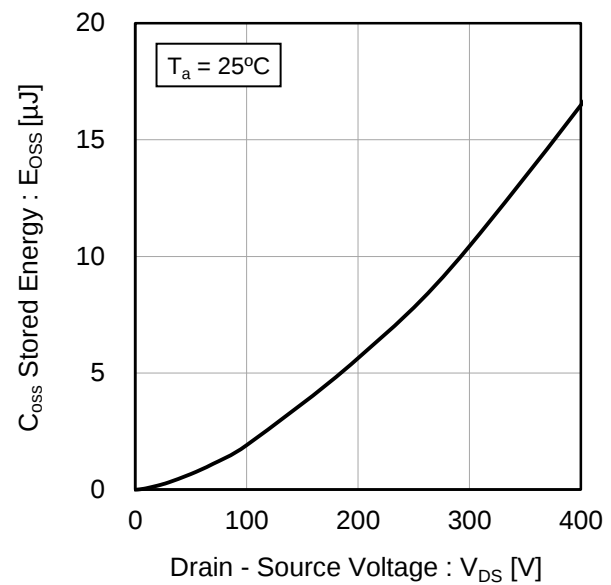
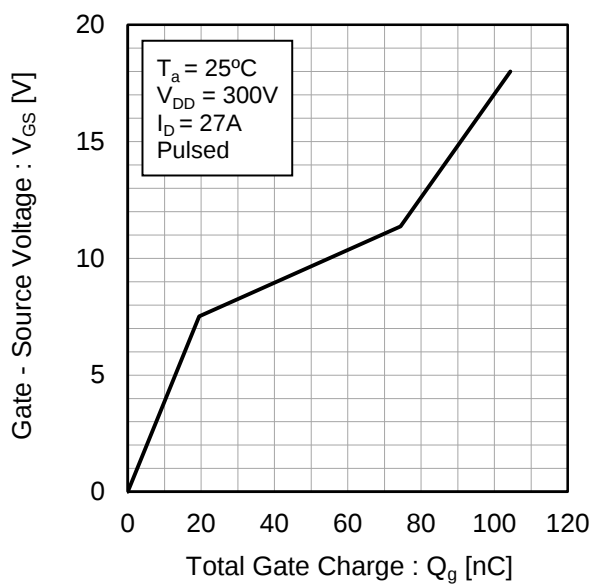
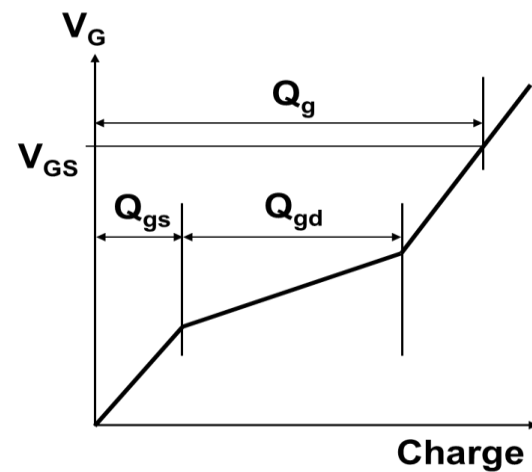


Fig.21 Dynamic Input Characteristics



*Gate Charge Waveform



●Electrical characteristic curves

Fig.22 Typical Switching Time
vs. External Gate Resistance

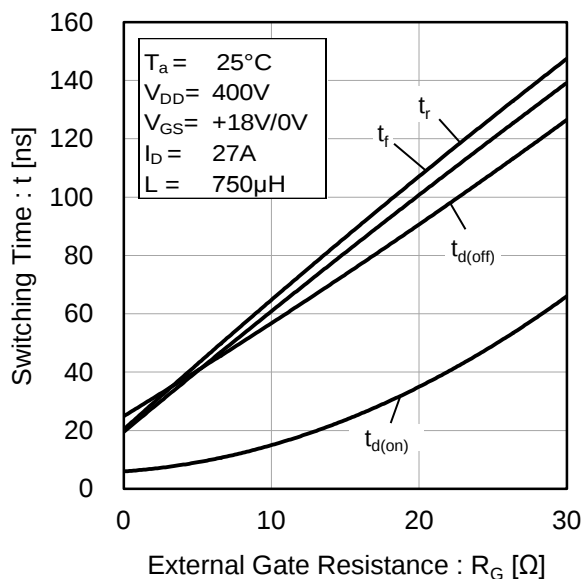


Fig.23 Typical Switching Loss
vs. Drain - Source Voltage

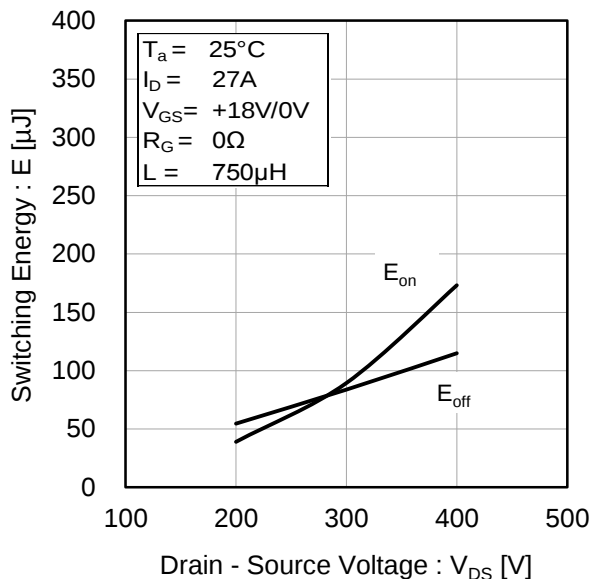


Fig.24 Typical Switching Loss
vs. Drain Current

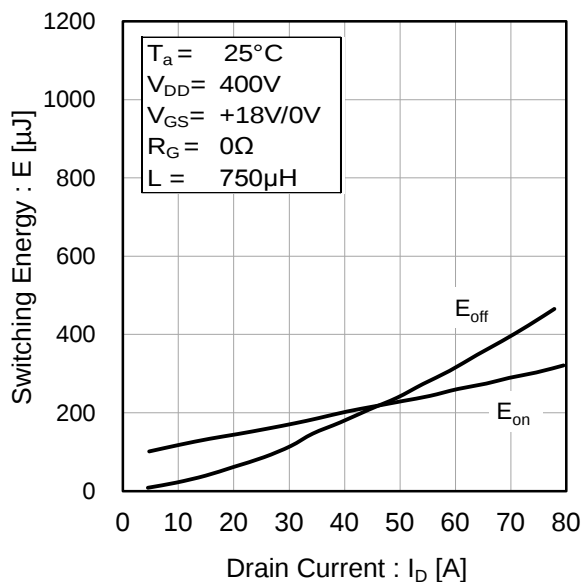
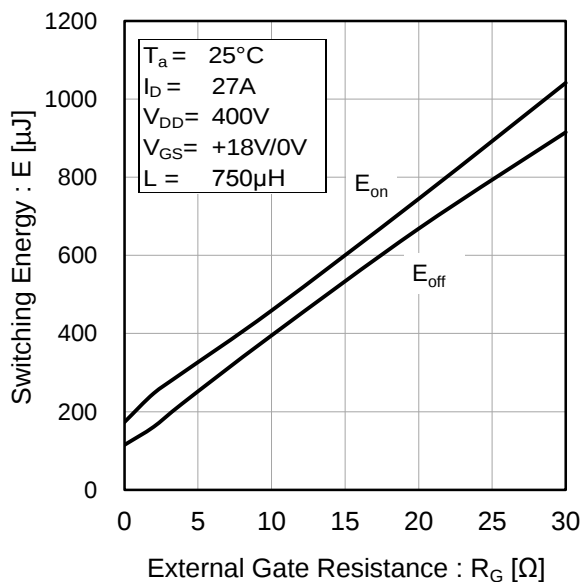


Fig.25 Typical Switching Loss
vs. External Gate Resistance



●Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

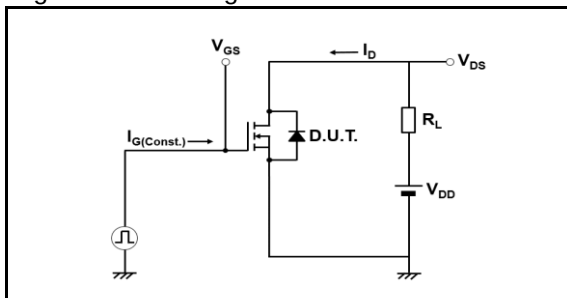


Fig.2-1 Switching Characteristics Measurement Circuit

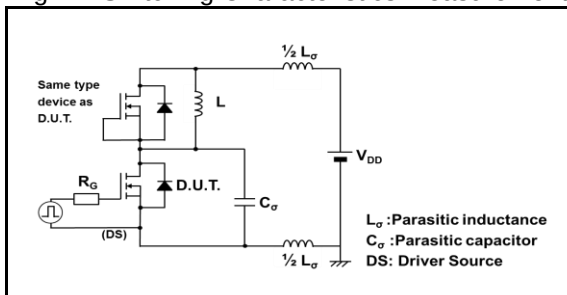


Fig.2-2 Waveforms for Switching Time

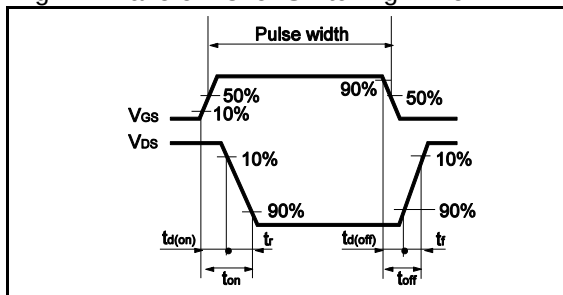


Fig.2-3 Waveforms for Switching Energy Loss

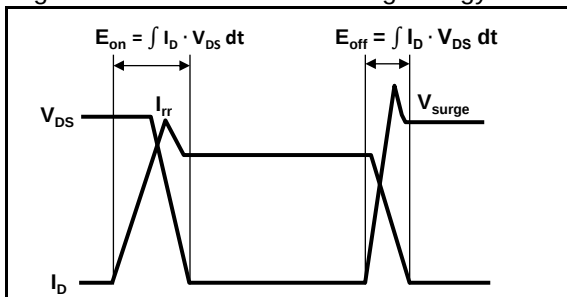


Fig.3-1 Reverse Recovery Time Measurement Circuit

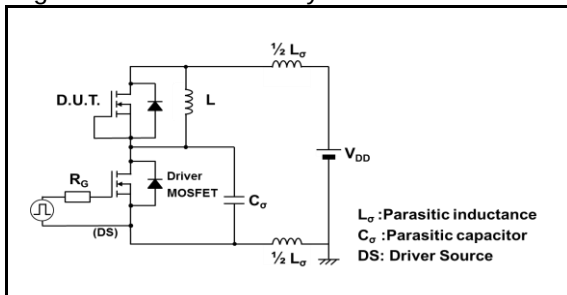
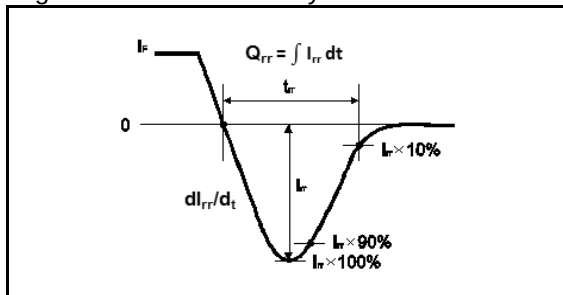


Fig.3-2 Reverse Recovery Waveform



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SCT3030AR - Web Page

Part Number	SCT3030AR
Package	TO-247-4L
Unit Quantity	450
Minimum Package Quantity	30
Packing Type	Tube
Constitution Materials List	inquiry
RoHS	Yes